

RV1S9213A

1 Mbps, OPEN COLLECTOR OUTPUT, HIGH CMTI, IPM DRIVER, 5-PIN SSOP WITH 8.2mm CREEPAGE DISTANCE (LSSO5) PHOTOCOUPLER

R08DS0187EJ0200 Rev.2.00 Oct. 24, 2025

DESCRIPTION

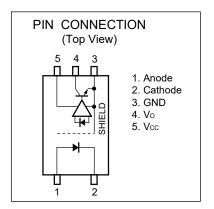
The RV1S9213A is an optically coupled isolator containing an AlGaAs LED on the input side and a photo diode and a signal processing circuit on the output side on one chip. The RV1S9213A is designed specifically for high common mode transient immunity (CMTI) and low pulse width distortion with operating temperature. It is suitable for IPM drive.

This package is very small and thin with long creepage distance (8.2mm).

This small product is suitable for various interface circuits which require surface mounting and high-density mounting.

FEATURES

- Small and long creepage (8.2 mm MIN, LSSO5)
- Open collector output
- High speed switching (tphl = 500 ns Max., tplh = 750 ns MAX.)
- Propagation Delay Difference (t_{PLH} t_{PHL} = 240 ns TYP.)
- Operating ambient temperature (125 °C MAX.)
- High common mode transient immunity (|CM_H|, |CM_L| = 50 kV/µs MIN.)
- High isolation voltage (BV = 5 000 Vr.m.s.)
- Embossed tape product: RV1S9213ACCSP-10Yx#KC0: 3 500 pcs/reel
- Pb-free product
- Safety standard
 - UL : UL1577, Double protection
 - CSA: CAN/CSA-C22.2 No.62368-1, Reinforced insulation
 - VDE: DIN EN IEC 60747-5-5 (Option)

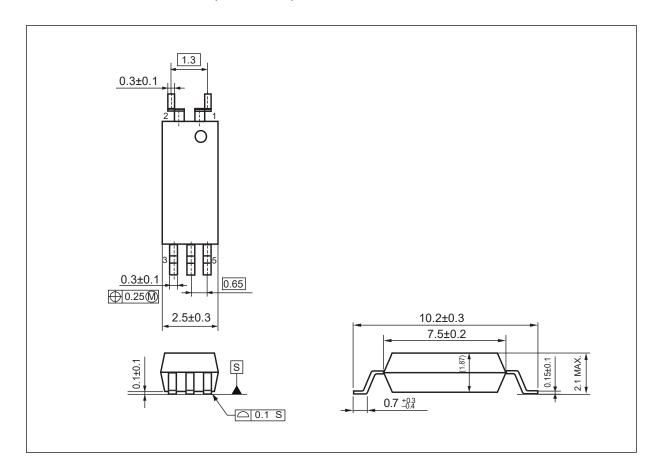


APPLICATIONS

- Robot controller
- Industrial inverter
- AC Servo
- FA Network
- · Measurement equipment

Start of mass production Nov.2019

PACKAGE DIMENSIONS (UNIT: mm)

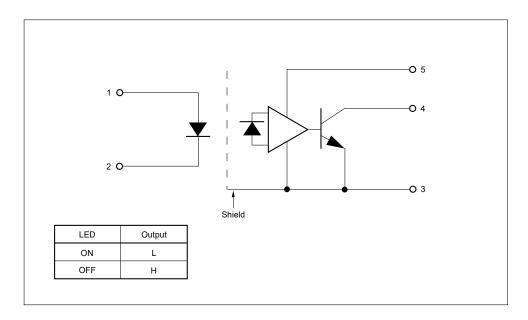


Weight: 0.075g (TYP.)

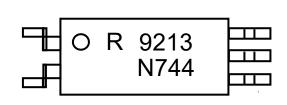
PHOTOCOUPLER CONSTRUCTION

Parameter	MIN.
Air Distance	8.2 mm
Creepage Distance	8.2 mm
Isolation Distance	0.15 mm

BLOCK DIAGRAM



MARKING EXAMPLE



F	3	An initial of "Renesas"		
92	13	Product Part Number *		
)	No.1 pin Mark		
N744	N	Rank Code		
	744	Assembly Lot		
		7 Last one-digit of Assembly Yea		
		44 Weekly Serial Code		

 $\ensuremath{\upsepsilon*}$) Applicable type numbers listed below

RV1S 9213 ACCSP-10Yx

Marking type number. "RV1S" and "ACCSP-10Yx" are omitted from original type number

ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number *1
RV1S9213ACCSP -10YC	RV1S9213ACCSP -10YC#SC0	SP Pb-Free and Halogen Free	Embossed Tape 20 pcs	UL, CSA Approved	RV1S9213A
	RV1S9213ACCSP -10YC#KC0	(Ni/Pd/Au)	Embossed Tape 3 500 pcs/reel		
RV1S9213ACCSP -10YV	RV1S9213ACCSP -10YV#SC0		Embossed Tape 20 pcs	UL, CSA, VDE Approved	
RV1S9213ACCSF -10YV#KC0	RV1S9213ACCSP -10YV#KC0		Embossed Tape 3 500 pcs/reel		

Notes: *1. For the application of the safety standard, the following part number should be used.

ABSOLUTELY MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current	l _F	20	mA
	Reverse Voltage	V _R	5	V
	Power Dissipation *1	P _D	45	mW
Detector	Supply Voltage	Vcc	-0.5 ~ +30	V
	Output Voltage	Vo	-0.5 ~ Vcc	V
	Output Current	lo	15	mA
	Power Dissipation *2	Pc	250	mW
Isolation \	/oltage *3	BV	5 000	Vr.m.s.
Operating	Ambient Temperature	TA	−40 ~ +125	°C
Storage T	emperature	T _{stg}	−40 ~ +150	°C

Notes: *1. Reduced to 1.2 mW/°C at T_A = 110 °C or more.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX	Unit
Supply Voltage	Vcc	4.5	15	25	V
Forward Current (ON)	I _{F (ON)}	8	10	12	mA
Forward voltage (OFF)	V _F (OFF)	-2		8.0	V

^{*2.} Reduced to 4.15 mW/°C at T_A = 85 °C or more.

^{*3.} AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output. Pins 1-2 shorted together, 3-5 shorted together.

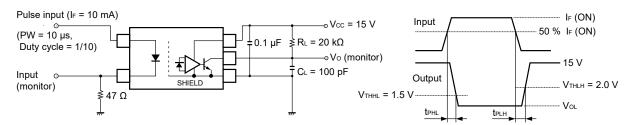
ELECTRICAL CHARACTERISTICS

 $(T_A = -40 \text{ to } +125 \text{ °C}, V_{CC} = 15 \text{ V}, \text{ unless otherwise specified})$

	Parameter	Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	V _F	I _F = 10 mA, T _A = 25 °C	1.35	1.56	1.75	V
	Reverse Current	I _R	V _R = 3 V, T _A = 25 °C			10	μΑ
	Terminal Capacitance	Ct	V _F = 0 V, f = 1 MHz		30		pF
Detector	High Level	Іссн	V _{CC} = 20 V, V _F = 0.8 V,		1.0	1.3	mA
	Supply Current *2		Vo = Open				
	Low Level	Iccl	$V_{CC} = 20 \text{ V}, I_F = 10 \text{ mA},$		1.0	1.3	mA
	Supply Current *2		V _O = Open				
	High Level	Іон	$V_{CC} = 20 \text{ V}, V_F = 0.8 \text{ V}$		0.01	50	μA
	Output Current *2						
	Low Level	V_{OL}	$V_{CC} = 15 \text{ V}, I_F = 10 \text{ mA},$		0.13	0.6	V
	Output Voltage		I _{OL} = 2.4 mA				
Coupled	Threshold Input Current *2	I _{FHL}	$V_{CC} = 15 \text{ V}, V_{O} = 0.8 \text{ V},$		0.8	5.0	mA
			I _O = 0.75 mA				
	Isolation Resistance	R _{I-O}	$V_{I-O} = 1 \text{ kV}_{DC}$	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1 MHz		0.7		pF
	Propagation Delay Time $(H \rightarrow L)^{*3}$	t _{PHL}	V_{CC} = 15 V, I _F =10 mA, R _L =20 kΩ, C _L = 100 pF		180	500	ns
	Propagation Delay Time $(L \rightarrow H)^{*3}$	t _{PLH}	V _{THHL} = 1.5 V, V _{THLH} = 2.0 V		420	750	
	Propagation Delay Difference	tрин - tрни		-200	240	650	
	Pulse Width Distortion	PWD =			240	650	
		t _{PHL} - t _{PLH}					
	Common Mode	[СМн]	$T_A = 25 ^{\circ}\text{C}, I_F = 0 \text{mA},$	50			kV/µs
	Transient Immunity at		$V_{CM} = 1.5 \text{ kV}, R_L = 20 \text{ k}\Omega,$				
	High Level Output *4		$C_L = 100 \text{ pF}, V_O > 3.0 \text{ V}$				
	Common Mode	[CM _L]	$T_A = 25 ^{\circ}\text{C}, I_F = 10 \text{mA},$	50			
	Transient Immunity at Low		$V_{CM} = 1.5 \text{ kV}, R_L = 20 \text{ k}\Omega,$				
	Level Output *4		$C_L = 100 \text{ pF}, V_O < 1.0 \text{ V}$				

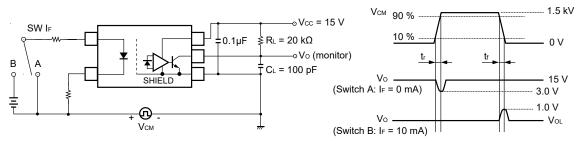
Notes*: 1. Typical values at $T_A = 25$ °C.

- 2. The polarity of the current flowing from the external circuit to the RV1S9213A is positive.
- 3. Test circuit for propagation delay time



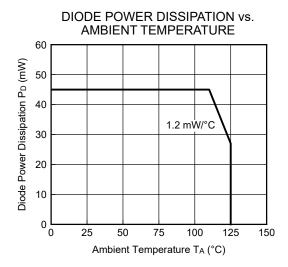
 $\ensuremath{\text{C}_{\text{L}}}$ includes probe and stray wiring capacitance.

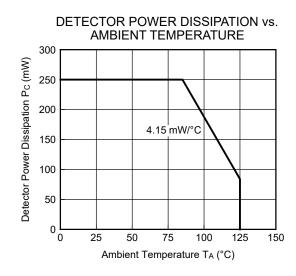
4. Test circuit for common mode transient immunity

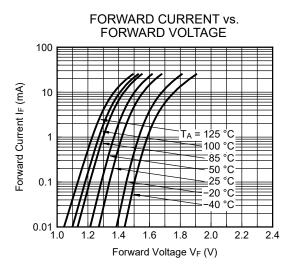


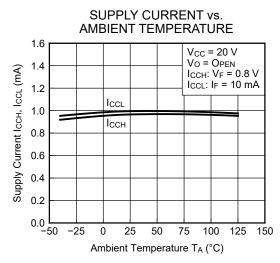
 $\ensuremath{\text{CL}}$ includes probe and stray wiring capacitance.

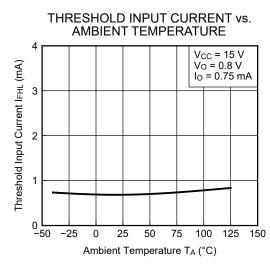
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)

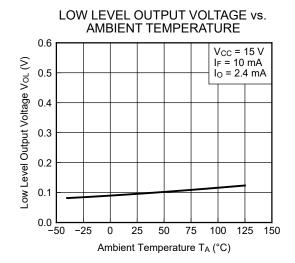






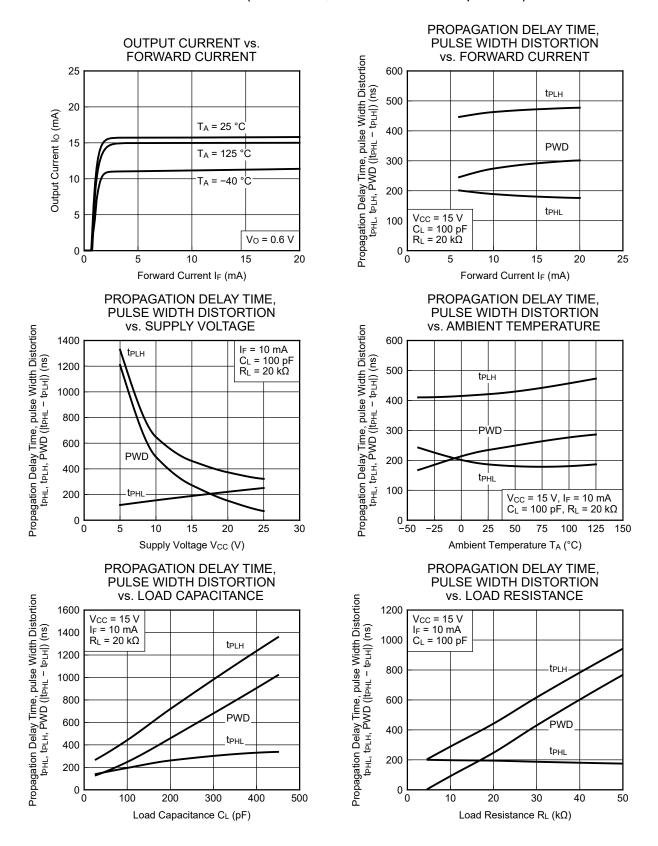






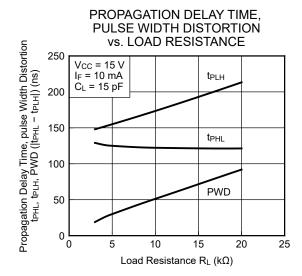
Remark The graphs indicate nominal characteristics.

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)



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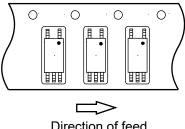
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)



Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)

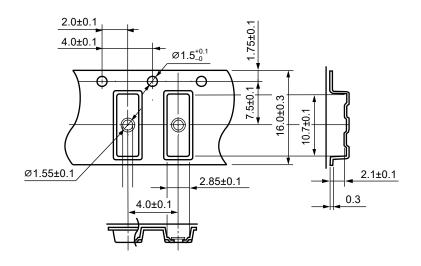
Tape Direction



Direction of feed

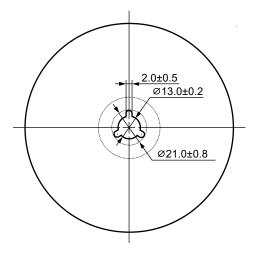
Outline and Dimensions (Tape)

(Unit: mm)

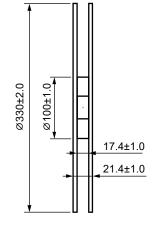


Outline and Dimensions (Reel)

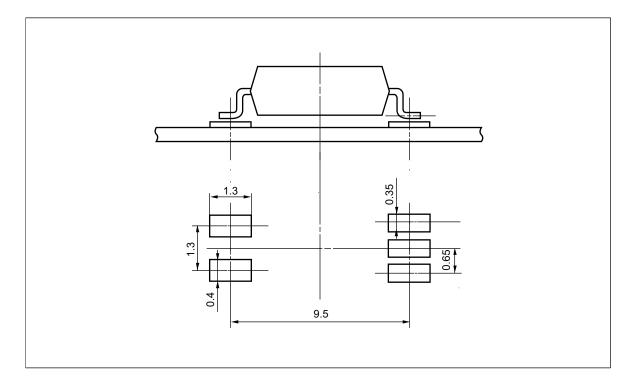
(Unit: mm)



Packing: 3 500 pcs/reel



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.

NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering

Peak reflow temperature
 260 °C or below (package surface temperature)

Time of peak reflow temperature
 Time of temperature higher than 220 °C
 60 s or less

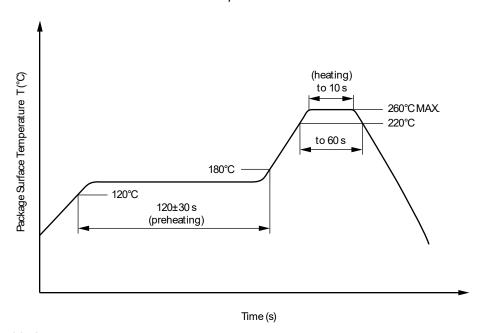
• Time to preheat temperature from 120 to 180 °C 120 \pm 30 s

Number of reflows
 Three

Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is

recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260 °C or below (molten solder temperature)

• Time 10 s or less

Preheating conditions 120 °C or below (package surface temperature)

Number of times One (Allowed to be dipped in solder including plastic mold portion.)
 Flux Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak temperature (lead part temperature)
 Time (per one side)
 350 °C or below
 3 s or less

Flux Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Place
 1.5 to 2.0 mm or more away from the root of the lead

(4) Cautions

Flux cleaning
 Fixing/Coating
 Avoid cleaning with Freon- or halogen-based (chlorinated etc.) solvents.
 Do not use fixing agents or coatings containing halogen-based substances.

RV1S9213A Data Sheet

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

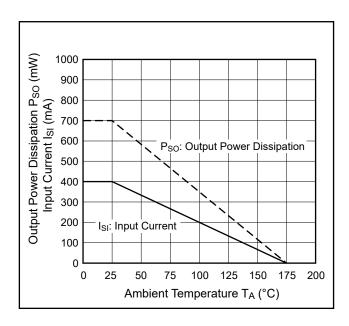
USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of more than 0.1 μ F is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.

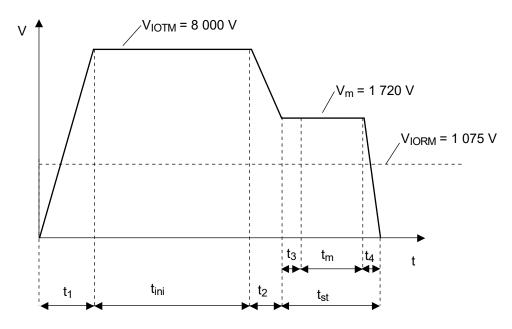
SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/125/21	
Dielectric strength			
maximum operating isolation voltage	Viorm	1 075	V_{peak}
Test voltage (partial discharge test, procedure a for type test and random	V _m	1 720	V_{peak}
test)			
$V_m = 1.6 \times V_{IORM.}, q_{pd} < 5 pC$			
Test voltage (partial discharge test, procedure b for all devices)	V _m	2 016	V_{peak}
$V_m = 1.875 \times V_{IORM.}$, $q_{pd} < 5 \text{ pC}$	v m	2 0 10	v peak
Highest permissible overvoltage	V _{IОТМ}	8 000	V_{peak}
Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11))	CTI	400	
Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		II	
Storage temperature range	T _{stg}	-40 to +150	°C
Operating temperature range	T _A	-40 to +125	°C
Isolation resistance, minimum value			
V _{I-O} = 500 V dc, T _A = 25 °C	R _{I-O} MIN.	10 ¹²	Ω
V_{I-O} = 500 V dc, T_A = maximum temperature of rating, at least 100 °C	R _{I-O} MIN.	10 ¹¹	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal			
derating curve)			
Maximum ambient temperature	Ts	175	°C
Maximum input current	Isı	400	mA
Maximum output power dissipation	Pso	700	mW
Isolation resistance, minimum value at V⊦o = 500 V dc, T _A = T _S	R _{I-O} MIN.	10 ⁹	Ω

Dependence of maximum safety ratings on ambient temperature



Method a) Destructive Test, Type and Sample Test



 t_1 , t_2 = 1 to 10 sec

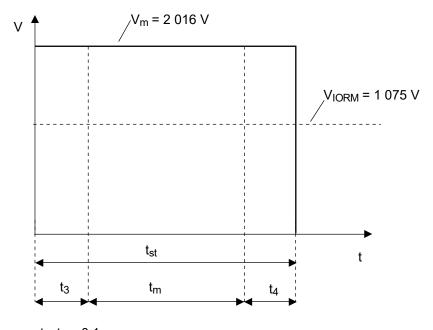
 t_3 , $t_4 = 1 \sec$

 $t_m = 10 sec$

 t_{st} = 12 sec

 $t_{ini} = 60 \text{ sec}$

Method b) Non-destructive Test, 100% Production Test



 t_3 , t_4 = 0.1 sec

 $t_m = 1.0 sec$

 t_{st} = 1.2 sec

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

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